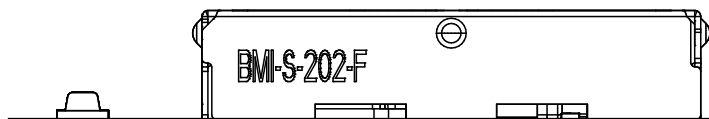
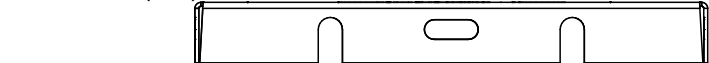
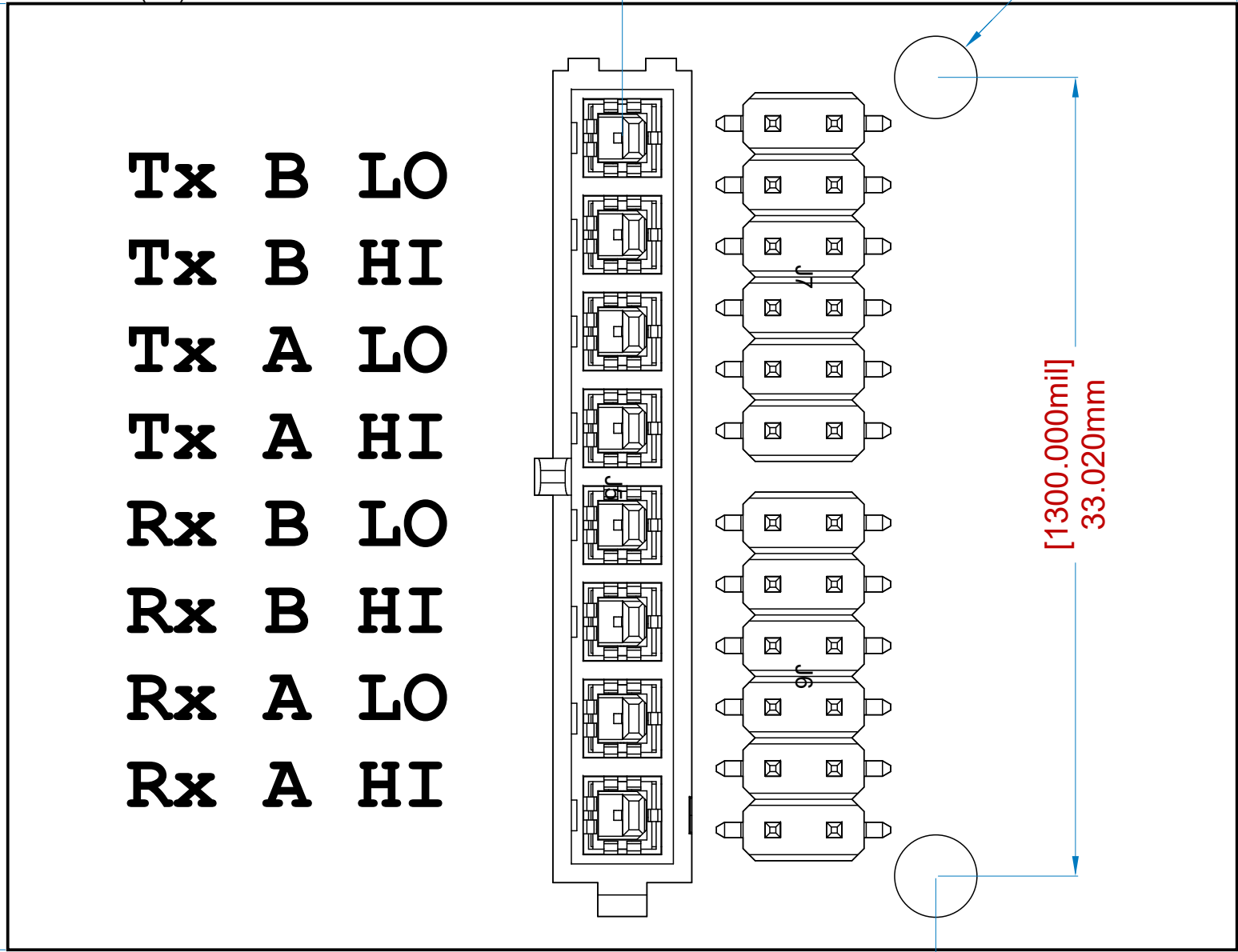


Side View (4:1)



Bottom View (4:1)



Layer Stack Legend

Material	Layer	Thickness	Dielectric	Material	Type	Gerber
	Top Paste				Paste Mask	GTP
	Top Overlay				Legend	GTO
Surface Material	Top Solder	0.400mil	Solder Resist		Solder Mask	GTS
Copper	Top Layer 1	1.400mil			Signal	GTL
Prepreg		10.000mil	VT-47		Dielectric	
Copper	GND Plane 2	1.417mil			Internal Plane	GP1
Core		10.000mil	VT-47		Dielectric	
Copper	RF Layer 3	1.417mil			Signal	G1
Prepreg		10.000mil	VT-47		Dielectric	
Copper	GND Plane 4	1.417mil			Internal Plane	GP2
Core		10.000mil	VT-47		Dielectric	
Copper	Signal Layer 5	1.417mil			Signal	G2
Prepreg		10.000mil	VT-47		Dielectric	
Copper	Bottom Layer 6	1.400mil			Signal	GBL
Surface Material	Bottom Solder	0.400mil	Solder Resist		Solder Mask	GBS
	Bottom Overlay				Legend	GBO
	Bottom Paste				Paste Mask	GBP

Total thickness: 59.268mil

VREF	VIN
13	09
14	10
15	11
16	12
GND	GND
VREF	VIN
05	01
06	02
07	03
08	04
GND	GND

Pin Map
(Bottom View)

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		UNLESS OTHERWISE SPECIFIED:		NAME	DATE	Skylark Wireless LLC	
		DIMENSIONS ARE IN INCHES			11/8/2017		
		TOLERANCES:		DRAWN		TITLE	
		FRACTIONAL ±		CHECKED			
		ANGULAR: MACH ± BEND ±		ENG APPR.			
		TWO PLACE DECIMAL ±		MFG APPR.			
		THREE PLACE DECIMAL ±		Q.A.			
		INTERPRET GEOMETRIC TOLERANCING PER:		COMMENTS:			
		MATERIAL				SIZE	DWG. NO.
NEXT ASSY	USED ON	FINISH				IRIS-FE-01-B	
APPLICATION		DO NOT SCALE DRAWING				SCALE: 1:1	WEIGHT: SHEET 1 OF 1